

CLAIMS

Accordingly, what is claimed is:

1. An electronic device comprising:
  - a first volume bounded by a first face;
  - a second volume bounded by a second face;
  - the second face indented from the first face;
  - a plurality of electronic components housed in the first volume;
  - one or more power supplies housed in the second volume; and
  - the electronic components operable to be powered by a cord to the one or more of the plurality of power supplies, the cord running from the indented second face to the first face.
2. The device of claim 1 wherein the second face is higher than the first face.
3. The device of claim 1 wherein the second face is lower than the first face.
4. The device of claim 1 the one or more power supplies is a plurality of power supplies.
5. The device of claim 4 wherein at least two of power supplies are disposed in separate sub-volumes of the second volume, separated by a structure disposed within the second volume.
6. The device of claim 5 further comprising a cover, the cover operable to project an outline upon the indentation that approximates the dimension of the first face.
7. The device of claim 6 wherein the cover comprises structures that approximate the structures disposed within the second volume.

8. The device of claim 1 further comprising a cover, the cover operable to project an outline upon the indentation that approximates the dimension of the first face.
9. The device of claim 1 wherein the second volume is operable to be coupled to the first volume.
10. The device of claim 1 wherein the first face is approximately parallel to the second face.
11. The device of claim 1 wherein the first face is not approximately parallel to the second face.
12. An enclosure for an electronic system comprising:
  - a first chassis, operable to enclose a plurality of electronic components, comprising:
    - a first face;
    - a second face opposite the first face;
    - electrical connections, for transferring electrical energy to any enclosed electronic components, disposed through the first face;
  - a second chassis, operable to enclose one or more power supplies, having a third face; and

wherein a portion of the third face is disposed in a plane that intersects the volume disposed between the first face and the second face.
13. The enclosure of claim 12 wherein the second chassis is higher than the first chassis.
14. The enclosure of claim 12 wherein the second chassis is lower than the first chassis.

15. The enclosure of claim 12 the second chassis is operable to enclose a plurality of power supplies.
16. The enclosure of claim 15 wherein at least two of power supplies are operable to be disposed in separate sub-volumes of the second chassis, separated by a structure disposed within the second chassis.
17. The enclosure of claim 16 further comprising a cover, the cover operable to project an outline upon the second chassis that approximates the dimension of the first face.
18. The enclosure of claim 17 wherein the cover comprises structures that approximate the structures disposed within the second chassis.
19. The enclosure of claim 12 further comprising a cover, the cover operable to project an outline upon the indentation that approximates the dimension of the first face.
20. The enclosure of claim 12 wherein the second chassis is operable to be selectively coupled to and uncoupled from the first chassis.
21. The enclosure of claim 12 wherein the first face is approximately parallel to the second face.
22. The enclosure of claim 12 wherein the first face is not approximately parallel to the second face.
23. The enclosure of claim 12 further comprising a plurality of first chasses.

24. The enclosure of claim 12 further comprising a plurality of second chasses.
25. An enclosure for an electronic system comprising:
  - a first chassis comprising:
    - a first volume operable to enclose a plurality of electronic components, the first volume defined by a first face and a second face opposite the first face;
    - electrical connections, for transferring electrical energy to any enclosed electronic components, disposed through the first face;
  - a second chassis comprising:
    - a second volume, operable to enclose one or more power supplies, defined at least in part by a third face; and
    - wherein the third face and the first face define an indentation, and the second volume is indented from the first volume.
26. The enclosure of claim 25 wherein the second chassis is higher than the first chassis.
27. The enclosure of claim 25 wherein the second chassis is lower than the first chassis.
28. The enclosure of claim 25 the second chassis is operable to enclose a plurality of power supplies.
29. The enclosure of claim 28 wherein at least two of power supplies are operable to be disposed in separate sub-volumes of the second chassis, separated by a structure disposed within the second chassis.

30. The enclosure of claim 29 further comprising a cover, the cover operable to project an outline upon the second chassis that approximates the dimension of the first face.

31. The enclosure of claim 30 wherein the cover comprises structures that approximate the structures disposed within the second chassis.

32. The enclosure of claim 25 further comprising a cover, the cover operable to project an outline upon the indentation that approximates the dimension of the first face.

33. The enclosure of claim 25 wherein the second chassis is operable to be selectively coupled to and uncoupled from the first chassis.

34. The enclosure of claim 25 wherein the first face is approximately parallel to the third face.

35. The enclosure of claim 25 wherein the first face is not approximately parallel to the third face.

36. The enclosure of claim 25 further comprising a plurality of first chasses.

37. The enclosure of claim 25 further comprising a plurality of second chasses.

38. An enclosure for an electronic system comprising:

means for enclosing a plurality of electronic components, defined by a first face and a second face opposite the first face;

means for making electrical connections disposed through the first face;

means for enclosing one or more power supplies, defined at least in part by a third face;  
and

wherein the third face and the first face define an indentation.